# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6709841

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
YEHONATAN DALLAL	03/18/2021
IDAN MICHAEL HORN	03/15/2021
SHAY LANDIS	03/15/2021
RAN BERLINER	03/31/2021
AMIT BAR-OR TILLINGER	03/15/2021

#### **RECEIVING PARTY DATA**

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	17195056

## **CORRESPONDENCE DATA**

**Fax Number:** (214)200-0853

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 2146515000

Email: ipdocketing@haynesboone.com
Correspondent Name: HAYNES AND BOONE, LLP
Address Line 1: 2323 VICTORY AVENUE

Address Line 2: SUITE 700

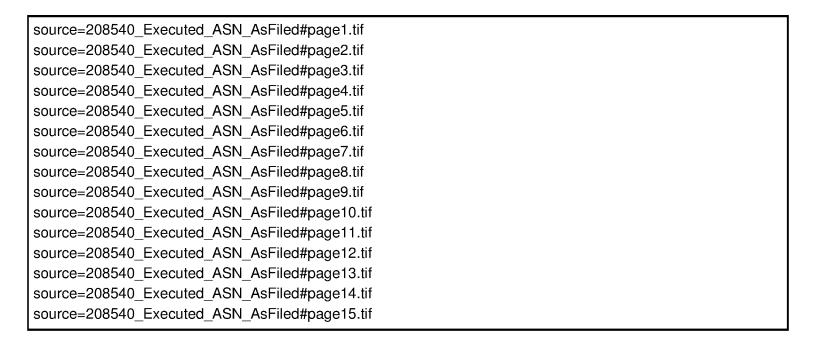
Address Line 4: DALLAS, TEXAS 75219

ATTORNEY DOCKET NUMBER:	49606.951US01 (208540)
NAME OF SUBMITTER:	GREGORY WEBB
SIGNATURE:	/GREGORY WEBB/
DATE SIGNED:	05/14/2021
Total Attachments: 15	•

Total Attachments: 15

PATENT REEL: 056240 FRAME: 0349

506663027



WHEREAS, WE,

- 1. Yehonatan Dallal, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
- 2. Idan Michael Horn, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
- 3. Shay Landis, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714.
- 4. Ran Berliner, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
- 5. Amit Bar-Or Tillinger, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to LINE-OF-SIGHT MULTIPLE-INPUT-MULTIPLE-OUTPUT (LOS-MIMO) COMMUNICATIONS USING FOCUSING ELEMENTS (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 17/195,056, filed March 8, 2021, Qualcomm Reference Number 208540 and all non-provisional applications relating thereto (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing

date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States:

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States or in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

PATENT
Qualcomm Reference Number: 208540
Page 3 of 3

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	Far Salva Israel, on	3/18/2021	Yehonatan DALLAL
	City, State, Country	Date	Yehonatan DALLAL
	ND WE HEREBY cover conflicting with the		ot execute any writing or do any act
Done at	, on		
	, on City, State, Country	Date	Idan Michael HORN
Done at	, on		
	City, State, Country	Date	Shay LANDIS
Done at	, on City, State, Country	Date	Ran BERLINER
Done at	. On		
	, on City. State. Country	Date	Amit BAR-OR TILLINGER

WHEREAS, WE,

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WHEREAS, **QUALCOMM Incorporated** (hereinafter "**ASSIGNEE**"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

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date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States or in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

Qualcomm Reference Number: 208540

Page 3 of 3

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	, on		
· · · · · · · · · · · ·	, on, City, State, Country	Date	Yehonatan DALLAL
	ND WE HEREBY covenant to ver conflicting with these presented		t execute any writing or do any act
Done at	City, State, Country	Vic h - Vizh Datè	Idan Michael HORN
Done at	on, on	Date	Shay LANDIS
Done at	, on	Date	Ran BERLINER
Done at	, on	Date	Amit BAR-OR TILLINGER

WHEREAS, WE,

- 1. Yehonatan Dallal, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
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WHEREAS, **QUALCOMM Incorporated** (hereinafter "**ASSIGNEE**"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 17/195,056, filed March 8, 2021, Qualcomm Reference Number 208540 and all non-provisional applications relating thereto (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing

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Qualcomm Reference Number: 208540

Page 3 of 3

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City,	on State, Country	Date	Yehonatan DALLAL
	E HEREBY covenant the flicting with these present		execute any writing or do any act
Dono at	O.F.		
City,	, on State, Country	Date	Idan Michael HORN
Done at 43/4	State, Country	<u>42~20</u> 24)	
			"Shay LANDIS
	, on State, Country		Ran BERLINER
City,	on State, Country	Date	Amit BAR-OR TILLINGER

WHEREAS, WE,

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	ver conflicting with these p	A DE WAR TO		
Done at	on, on			
	City, State, Country	Date	Yehonatan DALLAL	
			execute any writing or do any act	
vnatsoe <sup>,</sup>	ver conflicting with these p	resents.		
Done at	on, on			
	City, State, Country	Date	Idan Michael HORN	
Done at	, on, on	Date	Shay LANDIS	••••
Done at	Hed Hesketon on City, State, Country	3/3//2021		
•	City, State, Country	Date	Ran BERLINER	••••
Oone at	~~			
<i>ઝ</i> રાઇઇ, લધ <sub>્</sub>	, on City, State, Country	Date	Amit BAR-OR TILLINGER	****

**PATENT** REEL: 056240 FRAME: 0362

WHEREAS, WE,

- 1. Yehonatan Dallal, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714.
- Idan Michael Horn, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714.
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PATENT
Qualcomm Reference Number: 208540
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Done at Tel-Aww , I gravel on Mar - 15 , 2021

City, State, Country Date Amit BAR-OF TILLINGER

PATENT REEL: 056240 FRAME: 0365

**RECORDED: 05/14/2021**